Texas Instruments Inc. (DUNS# 00-732-1904) Supplier Name:

Contact Info: ti.com/support

Form/Declaration Type: Distribute - RoHS and IEC 62474 DB

Created on: 08/25/2022

Details for "SN74AHC1G14DCKR"

Current Product Information

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package Pins	Package body size (mm)	Total device mass (mg)*
SN74AHC1G14DCKR	NIPDAU	Level-1-260C-UNLIM	Ext-Mfg	DCK 5	1.25x2x0.9	7.2

*Total Device Mass

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

Environmental Ratings Information

RoHS	REACH	Green	IEC 62474 DB	
Yes	Yes	Yes	Yes	

Component Information

				Homogeneous Material Level		Component Level	
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire							
Not Categorized	Proprietary Materials		0.000001	0.006191	62	0.000014	0
Precious Metals	Gold	7440-57-5	0.016151	99.993809	999938	0.224231	2242
Sub-Total			0.016152	100	1000000	0.224245	2242
Die Attach Adhesive		-	-				
Precious Metals	Silver	7440-22-4	0.039561	73.000203	730002	0.549242	5492
Thermoplastics	Ероху	85954-11-6	0.014632	26.999797	269998	0.203142	2031
Sub-Total			0.054193	100	1000000	0.752384	7524
Lead Frame		·	-				
Copper and Its Alloys	Copper	7440-50-8	3.27726	96.39	963900	45.499591	454996
Copper and Its Alloys	Iron	7439-89-6	0.085	2.5	25000	1.180091	11801
Copper and Its Alloys	Phosphorus	7723-14-0	0.00442	0.13	1300	0.061365	614
Nickel and Its Alloys	Nickel	7440-02-0	0.0272	0.8	8000	0.377629	3776
Other Nonferrous Metals and Alloys	Lead	7439-92-1	0.00034	0.01	100	0.00472	47
Zinc and Its Alloys	Zinc	7440-66-6	0.00578	0.17	1700	0.080246	802
Sub-Total			3.4	100	1000000	47.203642	472036
Lead Frame Plating		-	-				
Nickel and Its Alloys	Nickel	7440-02-0	0.011414	95.116667	951167	0.158465	1585
Precious Metals	Gold	7440-57-5	0.000094	0.783333	7833	0.001305	13
Precious Metals	Palladium	7440-05-3	0.000492	4.1	41000	0.006831	68
Sub-Total			0.012	100	1000000	0.166601	1666
Mold Compound			-				
Other Inorganic Materials	Fused Silica	60676-86-0	3.116798	86.994984	869950	43.271829	432718
Other Plastics and Rubber	Carbon Black	1333-86-4	0.017914	0.500009	5000	0.248708	2487
Other Plastics and Rubber	Organic Phosphorus	1330-78-5	0.000179	0.004996	50	0.002485	25
Thermoplastics	Ероху	85954-11-6	0.447842	12.50001	125000	6.21758	62176
Sub-Total			3.582733	100	1000000	49.740602	497406
Semiconductor Device							
Ceramics / Glass	Doped Silicon	7440-21-3	0.137756	100	1000000	1.912525	19125
Sub-Total			0.137756	100	1000000	1.912525	19125
Total			7.202834			100	1000000

Important Note

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm

for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the **component** level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the **component**. See Glossary of Terms for more details.

Important Part Information

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

Product Content Methodology

For an explanation of the methods used to determine material weights, See Product Content Methodology

Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

Important Information/Disclaimer

TI bases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by TI. The material content information is provided by TI "as is."

For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 08/25/2022

RoHS: Means TI semiconductor products that are compliant with the current RoHS requirement that the maximum concentration values of the ten substances listed in RoHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (CI) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (Sb203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.